



SSC8028GT3

N-Channel Enhancement Mode MOSFET

Features

VDS	VGS	RDSon TYP	ID
20V	±16V	11mR@10V	12A
		16mR@4V5	

Applications

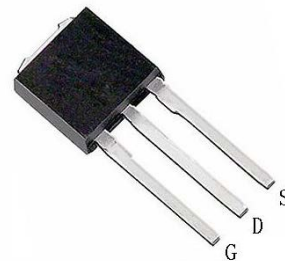
- Desktop Computer
- Notebook

General Description

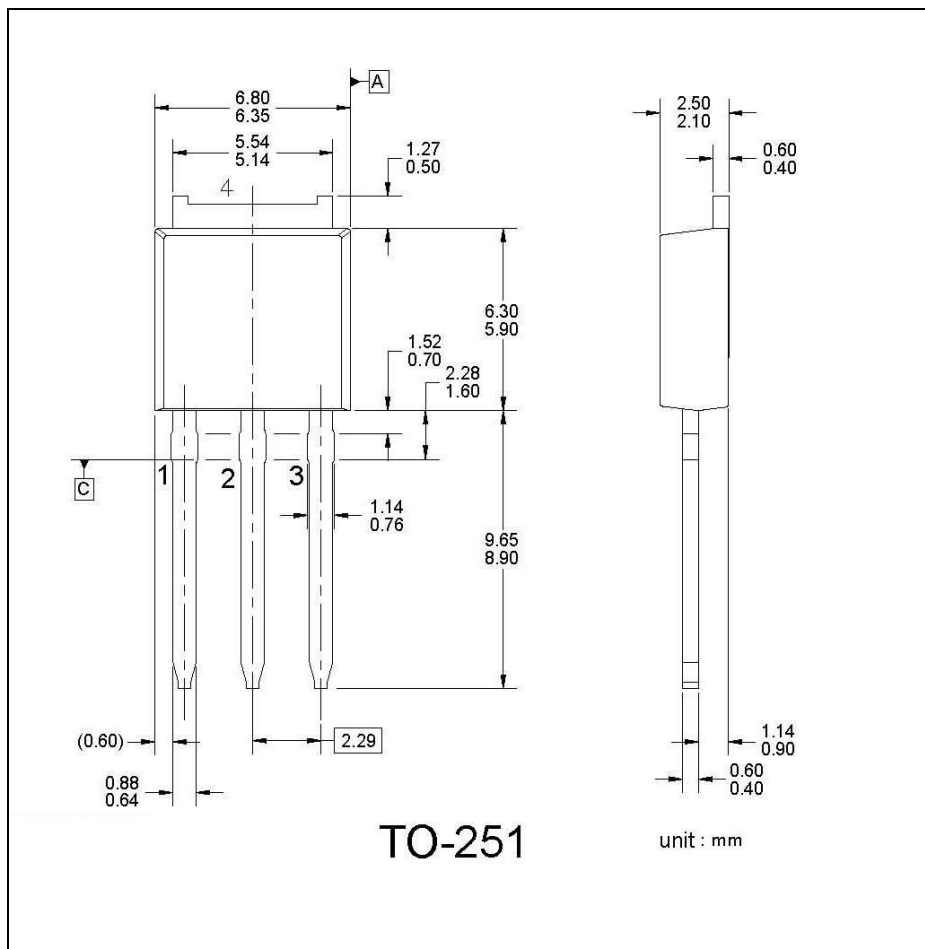
This device uses advanced trench technology to provide excellent RDS(ON) and low gate charge. This device is suitable for use as a load switch or in PWM applications.

Pin configuration

Top View



Package Information





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● **Absolute Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise noted**

Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V_{DSS}	20	V
Gate-Source Voltage		V_{GSS}	± 16	V
Drain Current (Note 1)	Continuous $T_A=25^\circ\text{C}$	I_D	12	A
	Pulsed (Note 2)	I_{DM}	30	A
Total Power Dissipation (Note 1)		P_D	2.5	W
Operating and Storage Junction Temperature Range		T_J, T_{STG}	-55 to 150	$^\circ\text{C}$

● **Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise noted**

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0\text{ V}, I_D = 250\mu\text{A}$	25	--	--	V
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1	2	3	V
Gate-Body Leakage Current	I_{GSS}	$V_{GS} = \pm 16\text{ V}, V_{DS} = 0\text{ V}$	--	--	± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 20\text{ V}, V_{GS} = 0\text{ V}$	--	--	1	μA
Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS} = 10\text{ V}, I_D = 12\text{ A}$	--	11	15	mR
		$V_{GS} = 4.5\text{ V}, I_D = 10\text{ A}$	--	16	20	
Forward Transconductance	G_{FS}	$V_{DS} = 5\text{ V}, I_D = 5\text{ A}$	--	7.3	--	S
Input Capacitance	C_{ISS}	$V_{DS} = 15\text{ V}, V_{GS} = 0\text{ V},$ $f = 1.0\text{ MHz}$	--	1270	--	pF
Output Capacitance	C_{OSS}		--	321	--	
Reverse Transfer Capacitance	C_{RSS}		--	185	--	
Turn-On Delay Time	$T_{D(ON)}$	$V_{DS} = 15\text{ V}, R_L = 15R,$ $I_{DS}=1A, V_{GS}=10V, R_{GEN}=6R$	--	17	--	nS
Turn-Off Delay Time	$T_{D(OFF)}$		--	41	--	
Diode Forward Voltage	V_{SD}	$V_{GS} = 0\text{ V}, I_S = 20\text{ A}$	--	0.84	1.29	V

Notes:

1. DUT is mounted on a 1in² FR-4 board with 2oz. Copper in a still air environment at 25°C , the current rating is based on the DC (<10s) test conditions.
2. Repetitive rating, pulse width limited by junction temperature. 300us Pulse Drain Current Tested.
3. Current limited by bond wire.

● Typical Performance Characteristics

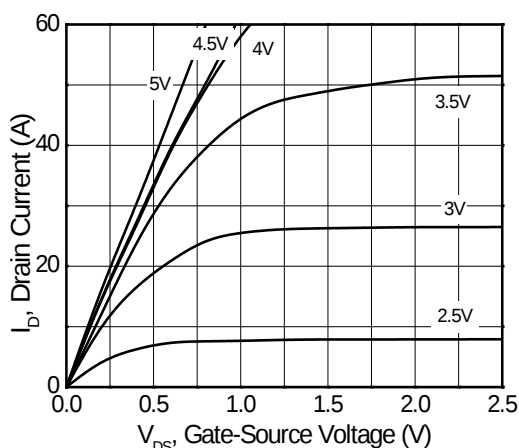


Fig1. Drain Current vs Drain-Source Voltage

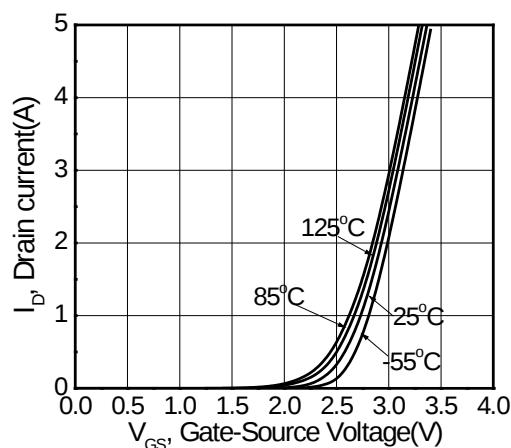


Fig2. Transfer Characteristics

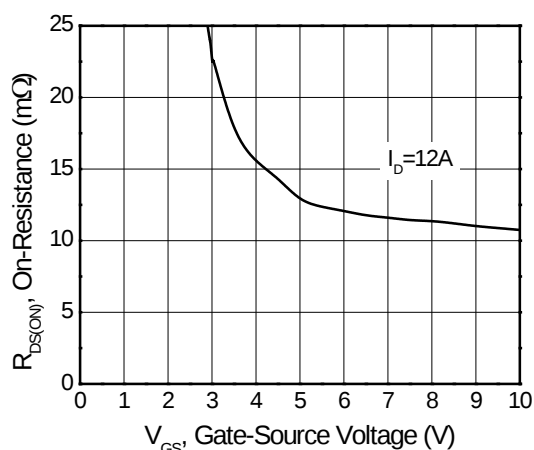


Fig3. On-Resistance vs. Gate-Source Voltage

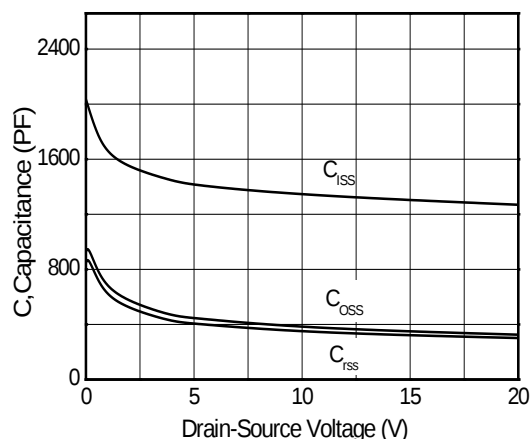


Fig4. Drain-Source Voltage vs. Capacitance

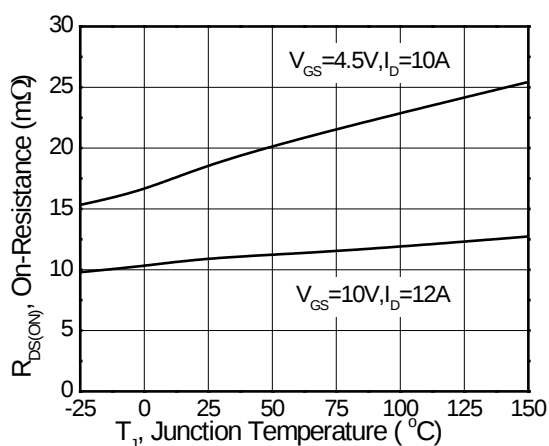


Fig5. On-Resistance vs. Junction Temperature

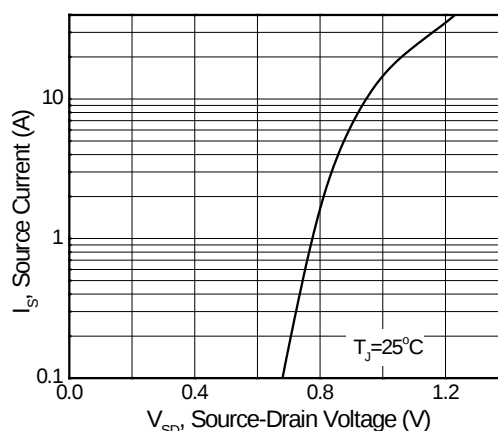


Fig6. Body Diode Forward Characteristics



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